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Http://www.100y.com.tw

# Low Cost, High Speed Rail-to-Rail Amplifiers

## AD8091/AD8092

#### **FEATURES**

Low cost single (AD8091) and dual (AD8092) amplifiers Fully specified at +3 V, +5 V, and ±5 V supplies Single-supply operation
Output swings to within 25 mV of either rail High speed and fast settling on 5 V
110 MHz, -3 dB bandwidth (G = +1)

110 MHz, –3 αΒ bandwidth (G = +1 145 V/μs slew rate

50 ns settling time to 0.1% Good video specifications (G = +2)

Gain flatness of 0.1 dB to 20 MHz;  $R_L = 150 \Omega$ 

0.03% differential gain error;  $R_L = 1 \text{ k}\Omega$ 

0.03% differential phase error;  $R_L = 1 \text{ k}\Omega$ 

Low distortion

-80 dBc total harmonic @ 1 MHz;  $R_L = 100 \Omega$ 

Outstanding load drive capability

Drives 45 mA, 0.5 V from supply rails

Drives 50 pF capacitive load (G = +1)

Low power of 4.4 mA per amplifier

#### **APPLICATIONS**

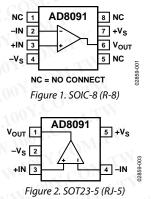
Coaxial cable drivers
Active filters
Video switchers
Professional cameras
CCD imaging systems
CDs/DVDs
Clock buffers

#### **GENERAL DESCRIPTION**

The AD8091 (single) and AD8092 (dual) are low cost, voltage feedback, high speed amplifiers designed to operate on  $+3~\rm V$ ,  $+5~\rm V$ , or  $\pm 5~\rm V$  supplies. The AD8091/AD8092 have true single-supply capability, with an input voltage range extending 200 mV below the negative rail and within 1 V of the positive rail.

Despite their low cost, the AD8091/AD8092 provide excellent overall performance and versatility. The output voltage swing extends to within 25 mV of each rail, providing the maximum output dynamic range with excellent overdrive recovery. This makes the AD8091/AD8092 useful for video electronics, such as cameras, video switchers, or any high speed portable equipment. Low distortion and fast settling make them ideal for active filter applications.

#### CONNECTION DIAGRAMS



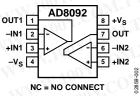


Figure 3. MSOP-8 and SOIC-8 (RM-8, R-8)

The AD8091/AD8092 offer a low power supply current and can operate on a single 3 V power supply. These features are ideally suited for portable and battery-powered applications where size and power are critical.

The wide bandwidth and fast slew rate make these amplifiers useful in many general-purpose, high speed applications where dual power supplies of up to  $\pm 6$  V and single supplies from +3 V to +12 V are needed.

This low cost performance is offered in an 8-lead SOIC (AD8091/AD8092), a tiny SOT23-5 (AD8091), and an MSOP (AD8092).

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## **SPECIFICATIONS**

Table 1.

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Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE	COM!	Ton COM	) 		
–3 dB Small Signal Bandwidth	$G = +1, V_0 = 0.2 \text{ V p-p}$	70	110		MHz
	$G = -1, +2, V_0 = 0.2 \text{ V p-p}$	V. COn	50		MHz
Bandwidth for 0.1 dB Flatness	$G = +2$ , $V_0 = 0.2$ V p-p, $R_L = 150$ Ω to 2.5 V, $R_F = 806$ Ω	M:100X'CO,	20		MHz
Slew Rate	$G = -1$ , $V_0 = 2 V$ step	100	145		V/µs
Full Power Response	$G = +1, V_0 = 2 V p-p$	1. 100 L	35		MHz
Settling Time to 0.1%	$G = -1$ , $V_0 = 2 V$ step	1001	50		ns
NOISE/DISTORTION PERFORMANCE	COM	WW. L			
Total Harmonic Distortion (See Figure 11)	$f_C = 5 \text{ MHz}, V_O = 2 \text{ V p-p}, G = +2$	M.100 F.	-67		dB
Input Voltage Noise	f = 10 kHz	11/1/1/100	16		nV/√Hz
Input Current Noise	f = 10 kHz	WWW.I	850		fA/√Hz
Differential Gain Error (NTSC)	$G = +2$ , $R_L = 150 \Omega$ to 2.5 V	V'	0.09		%
	$R_L = 1 \text{ k}\Omega \text{ to } 2.5 \text{ V}$	WWW	0.03		%
Differential Phase Error (NTSC)	$G = +2$ , $R_L = 150 \Omega$ to 2.5 V	MWW.L	0.19		Degrees
	$R_L = 1 \text{ k}\Omega \text{ to } 2.5 \text{ V}$	W.	0.03		Degrees
Crosstalk	f = 5  MHz, G = +2	MAN	-60		dB
DC PERFORMANCE	TAN CONTRACT	WWW	ON COM	W	
Input Offset Voltage	M. 100 1. CONT.		1.7	10	mV
WWW. OUX.CO. TW	T <sub>MIN</sub> to T <sub>MAX</sub>	11/1/		25	mV
Offset Drift	M.M. To ON COM.	N W	10 CO		μV/°C
Input Bias Current	M. 100 r. COW.T.		1.4	2.5	μA
WWW. LOOY.CO. TW	T <sub>MIN</sub> to T <sub>MAX</sub>	IN W.		3.25	μA
Input Offset Current	MINN. TO COME	W W	0.1	0.75	μΑ
Open-Loop Gain	$R_L = 2 k\Omega$ to 2.5 V	86	98		dB
WWW.CO.TW	T <sub>MIN</sub> to T <sub>MAX</sub>	TW	96		dB
	$R_L = 150 \Omega$ to 2.5 V	76	82		dB
	T <sub>MIN</sub> to T <sub>MAX</sub>	17.7	78		dB
NPUT CHARACTERISTICS	M. 100x	WII	W 100	,	M
Input Resistance	M. M.M. OOX.C.	WT	290		kΩ
Input Capacitance	TINW.IO	DM	1.4		pF
Input Common-Mode Voltage Range	IN 1001.	OM.TW	-0.2 to +4		V
Common-Mode Rejection Ratio	$V_{CM} = 0 \text{ V to } 3.5 \text{ V}$	72	88		dB
OUTPUT CHARACTERISTICS	TWW.Me	COMP	WWW	.10	1.CO
Output Voltage Swing	$R_L = 10 \text{ k}\Omega \text{ to } 2.5 \text{ V}$	J. COM.I.	0.015 to 4.985		V COM.
WWW.	$R_L = 2 k\Omega \text{ to } 2.5 \text{ V}$	0.100 to 4.900	0.025 to 4.975		V
	$R_L = 150 \Omega \text{ to } 2.5 \text{ V}$	0.300 to 4.625	0.200 to 4.800		A. COM
Output Current	$V_{OUT} = 0.5 \text{ V to } 4.5 \text{ V}$	Oh CONT	45		mA CON
WWW. Jany.C	T <sub>MIN</sub> to T <sub>MAX</sub>	100Y.	45		mA
Short-Circuit Current	Sourcing	L ON COM	80		mA C
M A 100 x	Sinking	Ton . COM	130		mA
Capacitive Load Drive	G = +1	1007.	50		pF
POWER SUPPLY	COM NIW	W. F. CON		WW	VA:
Operating Range	CONTIN	3.100 E CO		12	V
Quiescent Current/Amplifier	WY WY	1 100 X.CO	4.4	5	mA
Power Supply Rejection Ratio	$\Delta V_S = \pm 1 \text{ V}$	70	80	,	dB
OPERATING TEMPERATURE RANGE	¬ ¬ ¬ ¬ 1 v	-40	0	+85	°C
OF LIMITING FLIVIF ENATURE NAINGE	THE THE THE	1/240		۲٥٦	

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 $T_A = 25$ °C,  $V_S = +3$  V,  $R_L = 2$  k $\Omega$  to +1.5 V, unless otherwise noted.

			A-1/4		
Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE	TW WY	100X.	WILL		
–3 dB Small Signal Bandwidth	$G = +1, V_0 = 0.2 \text{ V p-p}$	70	110		MHz
	$G = -1, +2, V_0 = 0.2 \text{ V p-p}$	N.100 . CC	50		MHz
Bandwidth for 0.1 dB Flatness	$G = +2$ , $V_0 = 0.2$ V p-p, $R_L = 150$ Ω to 2.5 V, $R_F = 402$ Ω	N.100Y.C	17 TV		MHz
Slew Rate	$G = -1$ , $V_0 = 2 V$ step	90	135		V/µs
Full Power Response	$G = +1, V_0 = 1 V p-p$	MAN. OUX	65		MHz
Settling Time to 0.1%	$G = -1, V_0 = 2 V step$	WW.100	55		ns
NOISE/DISTORTION PERFORMANCE	1007.	7 100	W.T.W		
Total Harmonic Distortion (see Figure 11)	$f_C = 5$ MHz, $V_O = 2$ V p-p, $G = -1$ , $R_L = 100 \Omega$ to 1.5 V	WWW.100	-47 M.T.Y		dB
Input Voltage Noise	f = 10 kHz	WW.	16		nV/√Hz
Input Current Noise	f = 10 kHz	MWW.	600		fA/√Hz
Differential Gain Error (NTSC)	$G = +2, V_{CM} = 1 V$	TATE OF THE PARTY.	M. COM.		17.0 VII.2
WY ON CO. THE	$R_L = 150 \Omega \text{ to } 1.5 \text{ V}$	MM	0.11		%
	$R_L = 1 \text{ k}\Omega \text{ to } 1.5 \text{ V}$	WWW	0.09		%
Differential Phase Error (NTSC)	$G = +2$ , $V_{CM} = 1$ V		N.Ing COJ		,,,
N N N N N N N N N N N N N N N N N N N	$R_L = 150 \Omega$ to 1.5 V	1111	0.24		Degrees
	$R_L = 1 \text{ k}\Omega \text{ to } 1.5 \text{ V}$	WW	0.10		Degrees
Crosstalk	f = 5  MHz, G = +2	-11	-60		dB
DC PERFORMANCE	77 100	N	100	Mor	
Input Offset Voltage	M.M. COA. CO.	V V	1.6	10	mV
mpat onset voltage	T <sub>MIN</sub> to T <sub>MAX</sub>	- 1	TWW.IO	25	mV
Offset Drift	TIVIIN CO TIVIAX	11/1	10	. 23	μV/°C
Input Bias Current	M.M.W. CO. CO.	W	1.3	2.6	μΑ
input bias current	T <sub>MIN</sub> to T <sub>MAX</sub>	N. T.	1.5	3.25	μΑ
Input Offset Current	TMIN CO TMAX	TI	0.15	0.8	μΑ
Open-Loop Gain	$R_L = 2 k\Omega$	80	96	0.5	dB
open good dam	T <sub>MIN</sub> to T <sub>MAX</sub>		94		dB
	$R_L = 150 \Omega$	74	82		dB
	T <sub>MIN</sub> to T <sub>MAX</sub>	TW TW	76		dB
NPUT CHARACTERISTICS	TIVIIN CO TIVIAX	CONT.	70	1.10	ub.
Input Resistance	$T_{LM} = M_{LM}^{-100}$	. JOM'JA	290		kΩ
Input Capacitance	TW WWW 100	YTY	1.4		pF
Input Common-Mode Voltage Range	W. T.	COM	-0.2 to +2.0		V CO
Common-Mode Rejection Ratio	$V_{CM} = 0 \text{ V to } 1.5 \text{ V}$	72	88		dB
DUTPUT CHARACTERISTICS	VCM = 0 V to 1.5 V	12	00	-11	ab .
Output Voltage Swing	$R_L = 10 \text{ k}\Omega \text{ to } 1.5 \text{ V}$	ON COM	0.01 to 2.99		VOOY.C
Output voltage Swing	$R_L = 2 k\Omega \text{ to } 1.5 \text{ V}$	0.075 to 2.9	0.01 to 2.99		V
	$R_L = 150 \Omega \text{ to } 1.5 \text{ V}$	0.20 to 2.75	0.125 to 2.875		V 100 x.
Output Current	$V_{OUT} = 0.5 \text{ V to } 2.5 \text{ V}$	0.20 to 2.75	45		mA
Output Current	T <sub>MIN</sub> to T <sub>MAX</sub>	1100 -1 CO	45		mA
Short Circuit Current	Sourcing	11007.	60		mA
Short Circuit Cullett	Sinking	M. C.	90		
Capacitive Load Drive	G = +1	W.100 -	45		mA pF
POWER SUPPLY	G-TI	1007.	C 43		PΓ
	OV.CON.	VW VV		12	V
Operating Range	Ton COM'I	3	120M.	12	
Quiescent Current/Amplifier	AV - LOEV	100	4.2	4.8	mA
Power Supply Rejection Ratio DPERATING TEMPERATURE RANGE	$\Delta V_S = +0.5 \text{ V}$	68	80	. 05	dB ℃
DEDATING TEMPERATURE DANCE	A (111) 2	-40		+85	1 °C

 $T_A = 25$ °C,  $V_S = \pm 5$  V,  $R_L = 2$  k $\Omega$  to ground, unless otherwise noted.

Table 3.

	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE		100 Y.Co			
	$G = +1, V_0 = 0.2 V p-p$	70	110		MHz
	$G = -1, +2, V_0 = 0.2 \text{ V p-p}$	W.100 1. COM	50		MHz
	$G = +2$ , $V_O = 0.2$ V p-p, $R_L = 150$ Ω, $R_F = 1.1$ kΩ	W.100Y.CO	20		MHz
Slew Rate	$G = -1$ , $V_0 = 2 V$ step	105	170		V/µs
Full Power Response	$G = +1, V_0 = 2 V p-p$	MM. OOX.Co	40		MHz
Settling Time to 0.1%	$G = -1$ , $V_0 = 2 V$ step	WW.In	50		ns
NOISE/DISTORTION PERFORMANCE	001.C 211.TW	1001	COM.TV		
Total Harmonic Distortion (see Figure 11)	$f_C = 5 \text{ MHz}, V_O = 2 \text{ V p-p}, G = +2$	WWW.	<b>-71</b>		dB
	f = 10 kHz	TIMM Too	16		nV/√Hz
Input Current Noise	f = 10 kHz	M 100.	900		fA/√Hz
	$G = +2$ , $R_L = 150 \Omega$	WWW	0.02		%
	$R_L = 1 k\Omega$	, TANN TO	0.02		%
	$G = +2$ , $R_L = 150 \Omega$	1111	0.11		Degrees
	$R_L = 1 k\Omega$	MM	0.02		Degrees
	f = 5 MHz, G = +2	WW.	-60		dB
DC PERFORMANCE	1,511112,512	TAX	TOO ON		u D
Input Offset Voltage		MM	1.8	11	mV
	T <sub>MIN</sub> to T <sub>MAX</sub>		N.I.O	27	mV
Offset Drift	TMIN CO TMAX	11 11 11	10	27	μV/°C
Input Bias Current		W WW		2.6	1 -
	T to TAW. 100 COM.		1.4		μΑ
	T <sub>MIN</sub> to T <sub>MAX</sub>	In h	011 1007.	3.5	μΑ
Input Offset Current	n alowwise over Com	00	0.1	0.75	μA
	$R_L = 2 k\Omega$	88	96		dB
	T <sub>MIN</sub> to T <sub>MAX</sub>	70	96		dB
-TXN VI	$R_L = 150 \Omega$	78	82 80		dB dB
INPUT CHARACTERISTICS	T <sub>MIN</sub> to T <sub>MAX</sub>		80	v.co	UD
Input Resistance		$OM_{i,I,A}$	290		kΩ
Input Resistance		WTIE	1.4		pF
Input Common-Mode Voltage Range		$C_{OM}$	-5.2 to +4.0		V
	$V_{CM} = -5 \text{ V to } +3.5 \text{ V}$	72	-3.2 to +4.0		dB
OUTPUT CHARACTERISTICS	VCM = -3 V tO +3.3 V	12	00	100%	ub 1
-3111:	$R_L = 10 \text{ k}\Omega$	COM	-4.98 to +4.98		V
		1 0F to 1 1 0F			VCOM
	$R_L = 2 k\Omega$	-4.85 to +4.85	-4.97 to +4.97		V
	$R_L = 150 \Omega$	-4.45 to +4.30	-4.60 to +4.60		
	$V_{OUT} = -4.5 \text{ V to } +4.5 \text{ V}$	Ton COM'	45		mA
	T <sub>MIN</sub> to T <sub>MAX</sub>	100Y.	45		mA
	Sourcing	. COn	100		mA
	Sinking	N.100 COM	160		mA
	G = +1 (AD8091/AD8092)	1007	50	M. J.	pF
POWER SUPPLY		W. T. COL		WW	
Operating Range		3 100	M	12	V 100
Quiescent Current/Amplifier		11007.	4.8	5.5	mA
	$\Delta V_S = \pm 1 V$	68	80		dB
OPERATING TEMPERATURE RANGE	CONT	-40	OM	+85	°C
OPERATING TEMPERATURE RANGE	100X'COW'LM	-40	COM.TW		+85

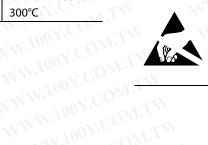
## **ABSOLUTE MAXIMUM RATINGS**

Table 4.

Parameter	Rating
Supply Voltage	12.6 V
Power Dissipation	See Figure 4
Common-Mode Input Voltage	±Vs
Differential Input Voltage	±2.5 V
Output Short-Circuit Duration	See Figure 4
Storage Temperature Range	−65°C to +125°C
Operating Temperature Range	-40°C to +85°C
Lead Temperature (Soldering 10 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

#### MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the AD8091/AD8092 package is limited by the associated rise in junction temperature (T<sub>1</sub>) on the die. The plastic encapsulating the die locally reaches the junction temperature. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the AD8091/AD8092. Exceeding a junction temperature of 175°C for an extended period of time can result in changes in the silicon devices, potentially causing failure.

The still-air thermal properties of the package  $(\theta_{JA})$ , the ambient temperature  $(T_A)$ , and the total power dissipated in the package  $(P_D)$  can be used to determine the junction temperature of the die.

The junction temperature can be calculated as

$$T_I = T_A + (P_D \times \theta_{IA})$$

The power dissipated in the package  $(P_D)$  is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins  $(V_s)$  times the quiescent current  $(I_s)$ . Assuming that the load  $(R_L)$  is referenced to midsupply, then the total drive power is  $V_s/2 \times I_{OUT}$ , some of which is dissipated in the package and some in the load  $(V_{OUT} \times I_{OUT})$ . The difference between the total drive power and the load power is the drive power dissipated in the package.

 $P_D$  = quiescent power + (total drive power – load power)

$$P_D = \left(V_S \times I_S\right) + \left(\left(\frac{V_S}{2} \times \frac{V_{OUT}}{R_L}\right) - \left(\frac{V_{OUT}^2}{R_L}\right)\right)$$

RMS output voltages should be considered. If  $R_L$  is referenced to  $-V_S$ , as in single-supply operation, then the total drive power is  $V_S \times I_{\rm OUT}$ .

If the rms signal levels are indeterminate, then consider the worst case when  $V_{\rm OUT} = V_{\rm S}/4$  for  $R_{\rm L}$  to midsupply

$$P_D = \left(V_S \times I_S\right) + \frac{\left(\frac{V_S}{4}\right)^2}{R_L}$$

In single-supply operation with  $R_L$  referenced to  $-V_s$ , the worst case is  $V_{OUT} = V_s/2$ .

Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$ . Also, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduces the  $\theta_{JA}$ . Care must be taken to minimize parasitic capacitances at the input leads of high speed op amps as discussed in the Input Capacitance section.

Figure 4 shows the maximum safe power dissipation in the package vs. the ambient temperature for the SOIC-8 (125°C/W), SOT23-5 (180°C/W), and MSOP-8 (150°C/W) on a JEDEC standard four-layer board.

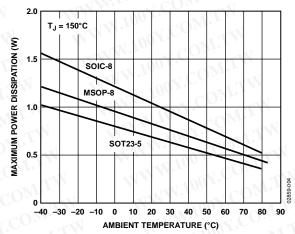


Figure 4. Maximum Power Dissipation vs. Temperature for a Four-Layer Board

## TYPICAL PERFORMANCE CHARACTERISTICS

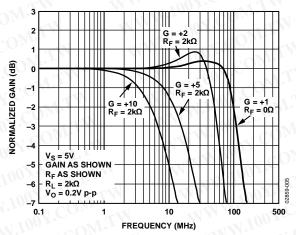


Figure 5. Normalized Gain vs. Frequency;  $V_S = +5 V$ 

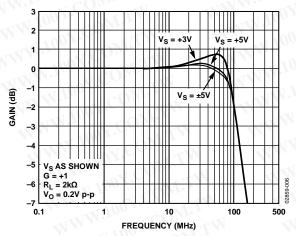


Figure 6. Gain vs. Frequency vs. Supply

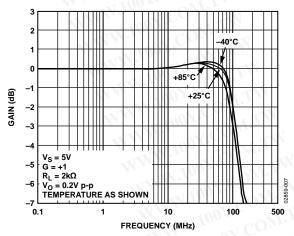


Figure 7. Gain vs. Frequency vs. Temperature

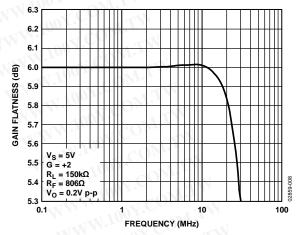


Figure 8. 0.1 dB Gain Flatness vs. Frequency; G = +2

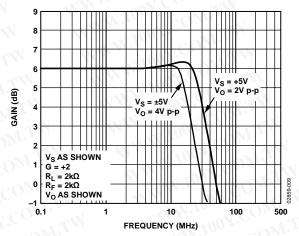


Figure 9. Large Signal Frequency Response; G = +2

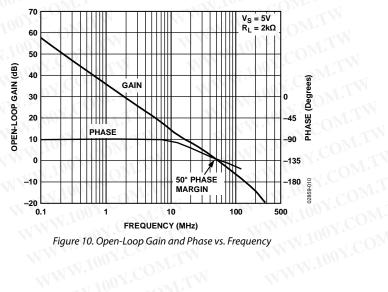


Figure 10. Open-Loop Gain and Phase vs. Frequency

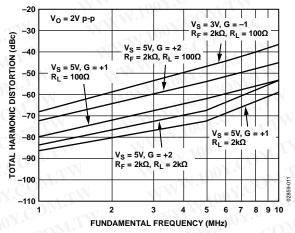


Figure 11. Total Harmonic Distortion

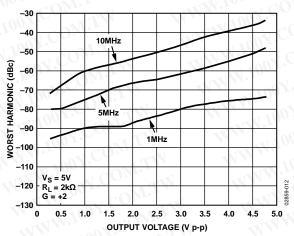


Figure 12. Worst Harmonic vs. Output Voltage

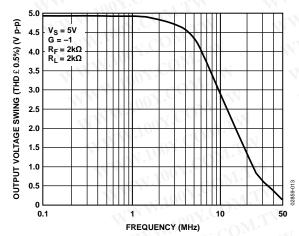


Figure 13. Low Distortion Rail-to-Rail Output Swing

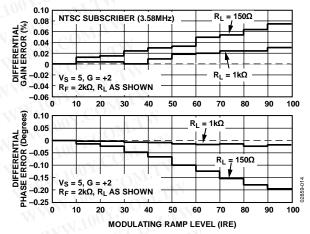


Figure 14. Differential Gain and Phase Errors

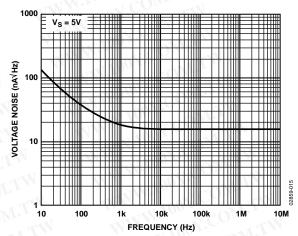


Figure 15. Input Voltage Noise vs. Frequency

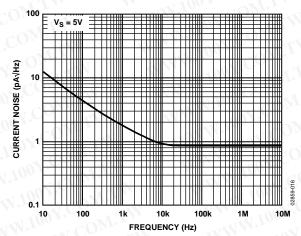


Figure 16. Input Current Noise vs. Frequency

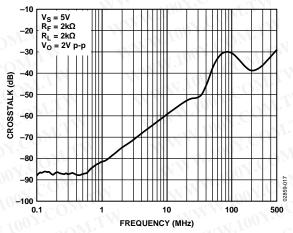


Figure 17. AD8092 Crosstalk (Output-to-Output) vs. Frequency

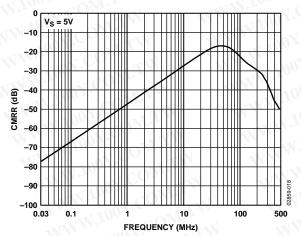


Figure 18. CMRR vs. Frequency

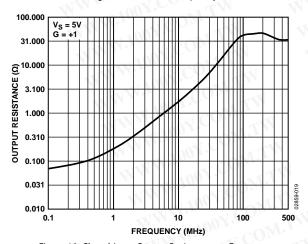


Figure 19. Closed-Loop Output Resistance vs. Frequency

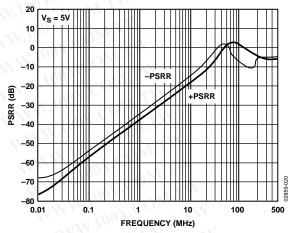


Figure 20. PSRR vs. Frequency

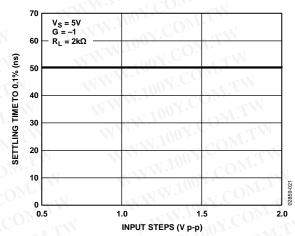


Figure 21. Settling Time vs. Input Step

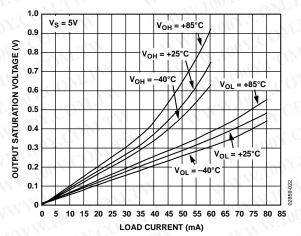


Figure 22. Output Saturation Voltage vs. Load Current

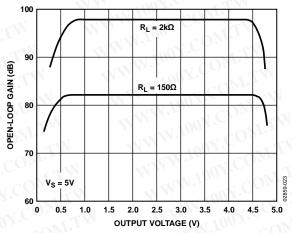


Figure 23. Open-Loop Gain vs. Output Voltage

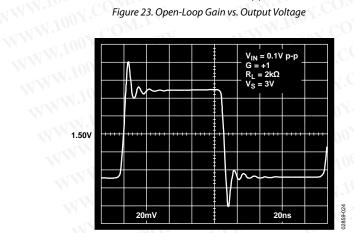


Figure 24. 100 mV Step Response; G = +1

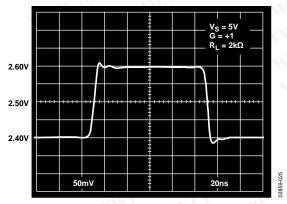


Figure 25. 200 mV Step Response;  $V_S = +5 V$ , G = +1WWW.100Y.COM.TW

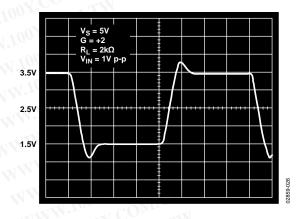


Figure 26. Large Signal Step Response;  $V_S = +5 V$ , G = +2 V

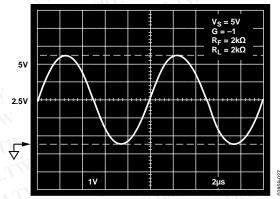


Figure 27. Output Swing; G = -1,  $R_L = 2 k\Omega$ 

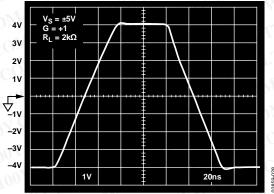


Figure 28. Large Signal Step Response;  $V_S = \pm 5 V$ , G = +1

## LAYOUT, GROUNDING, AND BYPASSING CONSIDERATIONS

#### **POWER SUPPLY BYPASSING**

Power supply pins are actually inputs, and care must be taken so that a noise-free stable dc voltage is applied. The purpose of bypass capacitors is to create low impedances from the supply to ground at all frequencies, thereby shunting or filtering a majority of the noise.

Decoupling schemes are designed to minimize the bypassing impedance at all frequencies with a parallel combination of capacitors. Chip capacitors of 0.01  $\mu F$  or 0.001  $\mu F$  (X7R or NPO) are critical and should be as close as possible to the amplifier package. Larger chip capacitors, such as the 0.1  $\mu F$  capacitor, can be shared among a few closely spaced active components in the same signal path. A 10  $\mu F$  tantalum capacitor is less critical for high frequency bypassing and, in most cases, only one per board is needed at the supply inputs.

#### **GROUNDING**

A ground plane layer is important in densely packed PC boards to spread the current-minimizing parasitic inductances. However, an understanding of where the current flows in a circuit is critical to implementing effective high speed circuit design. The length of the current path is directly proportional to the magnitude of parasitic inductances and thus the high frequency impedance of the path. High speed currents in an inductive ground return create an unwanted voltage noise.

The lengths of the high frequency bypass capacitor leads are most critical. A parasitic inductance in the bypass grounding works against the low impedance created by the bypass capacitor. Place the ground leads of the bypass capacitors at the same physical location. Because load currents flow from the supplies as well, the ground for the load impedance should be at the same physical location as the bypass capacitor grounds. For the larger value capacitors, which are intended to be effective at lower frequencies, the current return path distance is less critical.

#### **INPUT CAPACITANCE**

Along with bypassing and ground, high speed amplifiers can be sensitive to parasitic capacitance between the inputs and ground. A few pF of capacitance reduces the input impedance at high frequencies, in turn increasing the amplifier's gain and causing peaking of the frequency response or even oscillations, if severe enough. It is recommended that the external passive components, which are connected to the input pins, be placed as close as possible to the inputs to avoid parasitic capacitance. The ground and power planes must be kept at a distance of at least 0.05 mm from the input pins on all layers of the board.

#### INPUT-TO-OUTPUT COUPLING

The input and output signal traces should not be parallel to minimize capacitive coupling between the inputs and output and to avoid any positive feedback.

## DRIVING CAPACITIVE LOADS

A highly capacitive load reacts with the output of the amplifiers, causing a loss in phase margin and subsequent peaking or even oscillation, as shown in Figure 29 and Figure 30. There are two methods to effectively minimize its effect.

- Put a small value resistor in series with the output to isolate the load capacitor from the amplifier's output stage.
- Increase the phase margin with higher noise gains or by adding a pole with a parallel resistor and capacitor from
   -IN to the output.

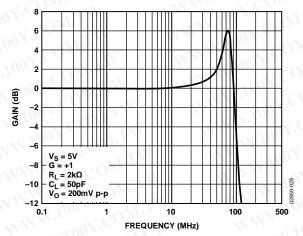


Figure 29. Closed-Loop Frequency Response:  $C_L = 50 \text{ pF}$ 

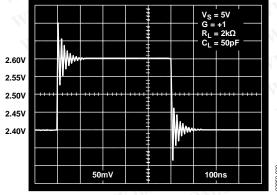


Figure 30. 200 mV Step Response:  $C_L = 50 pF$ 

As the closed-loop gain is increased, the larger phase margin allows for large capacitor loads with less peaking. Adding a low value resistor in series with the load at lower gains has the same effect. Figure 31 shows the effect of a series resistor for various voltage gains. For large capacitive loads, the frequency response of the amplifier is dominated by the series resistor and capacitive load.

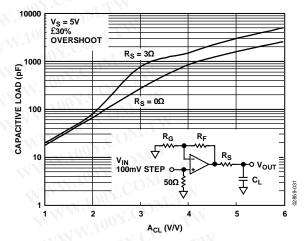


Figure 31. Capacitive Load Drive vs. Closed-Loop Gain

#### **OVERDRIVE RECOVERY**

Overdrive of an amplifier occurs when the output range and/or input range is exceeded. The amplifier must recover from this overdrive condition. The AD8091/AD8092 recover within 60 ns from negative overdrive and within 45 ns from positive overdrive, as shown in Figure 32.

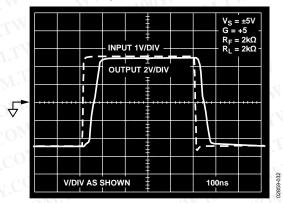


Figure 32. Overdrive Recovery

#### **ACTIVE FILTERS**

Active filters at higher frequencies require wider bandwidth op amps to work effectively. Excessive phase shift produced by lower frequency op amps can significantly impact active filter performance.

Figure 33 shows an example of a 2 MHz biquad bandwidth filter that uses three op amps. Such circuits are sometimes used in medical ultrasound systems to lower the noise bandwidth of the analog signal before A/D conversion. Note that the unused amplifiers' inputs should be tied to ground.

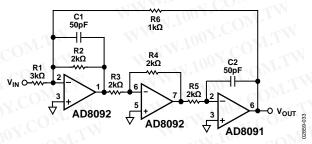


Figure 33. 2 MHz Biquad Band-Pass Filter

The frequency response of the circuit is shown in Figure 34

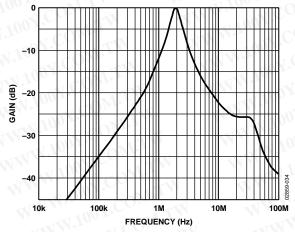


Figure 34. Frequency Response of 2 MHz Band-Pass Biquad Filter

#### SYNC STRIPPER

Synchronizing pulses are sometimes carried on video signals so as not to require a separate channel to carry the synchronizing information. However, for some functions, such as A/D conversion, it is not desirable to have the sync pulses on the video signal. These pulses reduce the dynamic range of the video signal and do not provide any useful information for such a function.

A sync stripper removes the synchronizing pulses from a video signal while passing all the useful video information. Figure 35 shows a practical single-supply circuit that uses only a single AD8091. It is capable of directly driving a reverse terminated video line.

The video signal plus sync is applied to the noninverting input with the proper termination. The amplifier gain is set equal to 2 via the two 1  $k\Omega$  resistors in the feedback circuit. A bias voltage must be applied to R1 for the input signal to have the sync pulses stripped at the proper level.

The blanking level of the input video pulse is the desired place to remove the sync information. The amplifier multiplies this level by 2. This level must be at ground at the output in order for the sync stripping action to take place. Because the gain of the amplifier from the input of R1 to the output is -1, a voltage equal to  $2 \times V_{BLANK}$  must be applied to make the blanking level come out at ground.

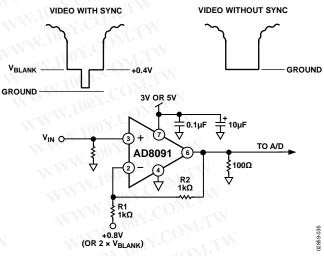


Figure 35. Sync Stripper

#### SINGLE-SUPPLY COMPOSITE VIDEO LINE DRIVER

Many composite video signals have their blanking level at ground and have video information that is both positive and negative. Such signals require dual-supply amplifiers to pass them. However, by ac level-shifting, a single-supply amplifier can be used to pass these signals. The following complications may arise from such techniques.

Signals of bounded peak-to-peak amplitude that vary in duty cycle require larger dynamic swing capacity than their (bounded) peak-to-peak amplitude after they are ac-coupled. As a worst case, the dynamic signal swing approaches twice the peak-to-peak value. One of two conditions that define the maximum dynamic swing requirements is a signal that is mostly low but goes high with a duty cycle that is a small fraction of a percent. The opposite condition defines the second condition.

The worst case of composite video is not quite this demanding. One bounding condition is a signal that is mostly black for an entire frame but has a white (full amplitude) minimum width spike at least once in a frame.

The other extreme is a full white video signal. The blanking intervals and sync tips of such a signal have negative-going excursions in compliance with the composite video specifications. The combination of horizontal and vertical blanking intervals limit such a signal to being at the highest (white) level for a maximum of about 75% of the time.

As a result of the duty cycles between the two extremes, a 1 V p-p composite video signal that is multiplied by a gain of 2 requires about 3.2 V p-p of dynamic voltage swing at the output for an op amp to pass a composite video signal of arbitrary varying duty cycle without distortion.

Some circuits use a sync tip clamp to hold the sync tips at a relatively constant level to lower the amount of dynamic signal swing required. However, these circuits can have artifacts like sync tip compression unless they are driven by a source with a very low output impedance. The AD8091/AD8092 have adequate signal swing when running on a single 5 V supply to handle an ac-coupled composite video signal.

The input to the circuit shown in Figure 36 is a standard composite (1 V p-p) video signal that has the blanking level at ground. The input network level shifts the video signal by means of ac coupling. The noninverting input of the op amp is biased to half of the supply voltage.

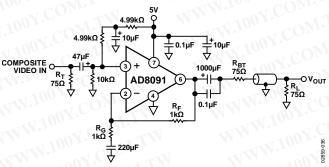
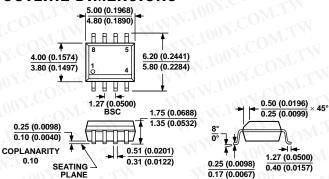


Figure 36. Single-Supply Composite Video Line Driver

The feedback circuit provides unity gain for the dc biasing of the input and provides a gain of 2 for any signals that are in the video bandwidth. The output is ac-coupled and terminated to drive the line.

The capacitor values provide minimum tilt or field time distortion of the video signal. These values are required for video that is considered to be studio or broadcast quality. However, if a lower consumer grade of video, sometimes referred to as consumer video, is all that is desired, the values and the cost of the capacitors can be reduced by as much as a factor of 5 with minimum visible degradation in the picture.

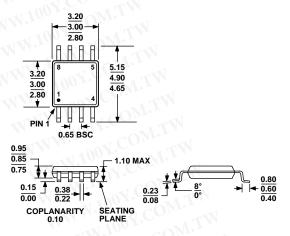
## **OUTLINE DIMENSIONS**



#### COMPLIANT TO JEDEC STANDARDS MS-012-AA

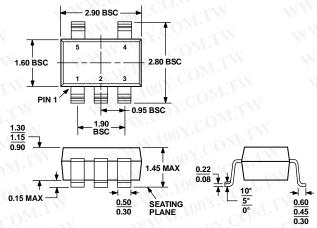
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 37. 8-Lead Standard Small Outline Package [SOIC\_N] Narrow Body (R-8) Dimensions shown in millimeters and (inches)



#### **COMPLIANT TO JEDEC STANDARDS MO-187-AA**

Figure 38. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters



#### **COMPLIANT TO JEDEC STANDARDS MO-178-AA**

Figure 39. 5-Lead Small Outline Transistor Package [SOT-23] (RJ-5) Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
AD8091AR	-40°C to +85°C	8-Lead SOIC	R-8	
AD8091AR-REEL	-40°C to +85°C	8-Lead SOIC, 13"Tape and Reel	R-8	
AD8091AR-REEL7	-40°C to +85°C	8-Lead SOIC, 7"Tape and Reel	R-8	
AD8091ARZ <sup>1</sup>	−40°C to +85°C	8-Lead SOIC	R-8	
AD8091ARZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead SOIC, 13"Tape and Reel	R-8	
AD8091ARZ-REEL71	-40°C to +85°C	8-Lead SOIC, 7"Tape and Reel	R-8	
AD8091ART-R2	-40°C to +85°C	5-Lead SOT-23	RJ-5	HVA
AD8091ART-REEL	-40°C to +85°C	5-Lead SOT-23, 13" Tape and Reel	RJ-5	HVA
AD8091ART-REEL7	-40°C to +85°C	5-Lead SOT-23, 7" Tape and Reel	RJ-5	HVA
AD8091ARTZ-R2 <sup>1</sup>	-40°C to +85°C	5-Lead SOT-23	RJ-5	HVA#
AD8091ARTZ-R7 <sup>1</sup>	-40°C to +85°C	5-Lead SOT-23, 7" Tape and Reel	RJ-5	HVA#
AD8091ARTZ-RL <sup>1</sup>	-40°C to +85°C	5-Lead SOT-23, 13" Tape and Reel	RJ-5	HVA#
AD8092AR	-40°C to +85°C	8-Lead SOIC	R-8	
AD8092AR-REEL	-40°C to +85°C	8-Lead SOIC, 13"Tape and Reel	R-8	ITW
AD8092AR-REEL7	-40°C to +85°C	8-Lead SOIC, 7"Tape and Reel	R-8	
AD8092ARZ <sup>1</sup>	-40°C to +85°C	8-Lead SOIC	R-8	M.r.
AD8092ARZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead SOIC, 13" Tape and Reel	R-8	MITW
AD8092ARZ-REEL7 <sup>1</sup>	-40°C to +85°C	8-Lead SOIC, 7"Tape and Reel	R-8	OW
AD8092ARM	-40°C to +85°C	8-Lead MSOP	RM-8	HWA
AD8092ARM-REEL	-40°C to +85°C	8-Lead MSOP, 13" Tape and Reel	RM-8	HWA
AD8092ARM-REEL7	-40°C to +85°C	8-Lead MSOP, 7" Tape and Reel	RM-8	HWA
AD8092ARMZ <sup>1</sup>	-40°C to +85°C	8-Lead MSOP	RM-8	HWA#
AD8092ARMZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead MSOP, 13" Tape and Reel	RM-8	HWA#
AD8092ARMZ-REEL71	-40°C to +85°C	8-Lead MSOP, 7" Tape and Reel	RM-8	HWA#

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